

# 25G SFP28 850nm 100m DOM **Transceiver**

QFX-SFP-25G-SR-LL



#### **Application**

· 25GBASE-SR Ethernet

#### **Standards**

- SFF-8472
- SFF-8024
- SFF-8431
- SFF-8432

#### **Features**

- Supports 25.78Gb/s Bit Rate
- Hot-pluggable SFP+ Footprint
- 850nm VCSEL Laser and PIN Photo-detector
- Internal CDR on Transmitter and Receiver Channel
- · RoHS-10 Compliant

- Link Lengths at 25.78G 100m Over OM4 MMF
- LC Duplex Connector
- Low Power Consumption < 1W
- 0°C to 70°C Operating Temperature Range
- Single +3.3V±5% Power Supply
- · Programmable TX Input Equalizer
- Programmable RX Pre-emphasis
- Digital Monitoring SFF-8472 Compliant



#### **Description**

The 25G SR short-wavelength transceiver is designed for use in 25.78Gb/s data rate over multimode fiber. The transceiver is compliant with SFF-8431, and the mechanical SFP+ plug is compatible with SFF-8432. Digital diagnostics functions are available via a 2-wire serial interface, as specified in SFF-8472.

#### **Product Specifications**

#### **I. Absolute Maximum Ratings**

Parameter	Symbol	Min.	Max.	Unit
Supply Voltage	Vcc	-0.3	+4.0	V
Storage Temperature	Ts	-40	+85	°C
Operating Humidity	RH	0	+85	%

#### **II. General Specifications**

Parameter	Symbol	Min.	Тур.	Max.	Unit
Bit Rate	BR		25.78		Gbps
Bit Error Ratio	BER			5*10 <sup>E-5</sup>	
Max. Supported Link Length	$L_{MAX}$			100	m

#### **III. Recommended Operating Conditions**

Parameter	Symbol	Min.	Тур.	Max.	Unit
Operating Temperature	Tc	0		+70	°C
Power Supply Voltage	Vcc	3.14	3.3	3.46	V
Bit Rate	BR		25.78		Gbps
Max. Supported Link Length	L <sub>MAX</sub>			100	m



# **IV. Electrical Characteristics**

Parameter	Symbol	Min.	Тур.	Max.	Unit	Note
Supply Voltage	V <sub>CC</sub>	3.14	3.3	3.46	V	
Supply Current	lcc			230	mA	
		Transmit	ter			
Input Differential Impedance	R <sub>IN</sub>	80	100	120	Ω	1
Single Ended Data Input Swing	$V_{IN}$	90		500	mVp-p	
Transmit Disable Voltage	$V_{DIS}$	2		$V_{\text{CCHOST}}$	V	
Transmit Enable Voltage	$V_{\text{EN}}$	$V_{\text{EE}}$		V <sub>EE</sub> +0.8	V	
Transmit Fault Assert Voltage	$V_{FA}$	2		$V_{\text{CCHOST}}$	V	
Transmit Fault De-Assert Voltage	$V_{\text{FDA}}$	$V_{\text{EE}}$		V <sub>EE</sub> +0.8	V	
		Receive	er			
Single Ended Data Output Swing	$V_{OD}$	200		500	mVp-p	
LOS Fault	$V_{LOSFT}$	2		$V_{\text{CCHOST}}$	V	
LOS Normal	$V_{LOSNR}$	$V_{\text{EE}}$		V <sub>EE</sub> +0.8	V	

#### Notes:

1. Differential between TD+ / TD-.



# **V. Optical Characteristics**

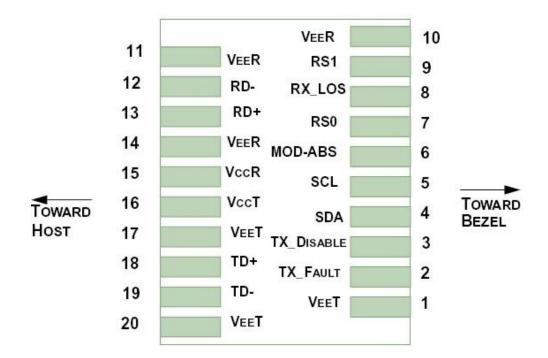
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note	
Transmitter							
Nominal Wavelength	λ	840		860	nm		
Spectral Width	Δλ			0.6	nm		
<b>Optical Modulation Amplitude</b>	POMA	-6.4		3	dBm		
<b>Optical Output Power</b>	Pav	-8.4		2.4	dBm		
Extinction Ratio	ER	2			dB		
Transmitter and Dispersion Penalty	TDP			5	dB		
Average Launch Power of OFF Transmitter	P <sub>OFF</sub>			-30	dBm		
Receiver							
Center Wavelength	λ	840		860	nm		
Average Receiver Power	$P_{AVG}$	-10.3		2.4	dBm	1	
Stressed Receiver Sensitivity (OMA)	$R_{SENSE}$			-5.2	dBm	2	
Receiver Reflectance	$R_{REFL}$			-12	dB		
Assert LOS	LOS <sub>A</sub>	-30			dBm		
De-Assert LOS	LOS <sub>D</sub>			-13	dBm		
LOS Hysteresis		0.5			dB		

#### Notes:

- 1. Sensitivity for 25.78G PRBS 231-1 and BER better than or equal to  $5*10^{E-5}$ .
- 2. The stressed sensitivity values in the table are for system level BER measurements which include the effects of CDR circuit.



#### **VI. Pin Assignment**

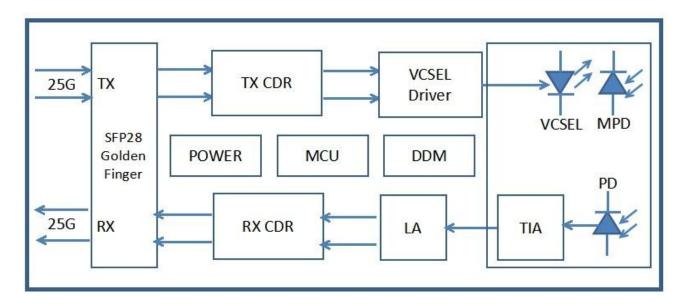




Pin Number	Symbol	Name	Description		
1,17,20	VeeT	Transmitter Signal Ground	These pins should be connected to signal ground on the host board.		
2	TX Fault	Transmitter Fault Out (OC)	$Logic~"1"~Output = Transmitter~Fault\\ Logic~"0"~Output = Normal~Operation\\ This pin is open collector compatible, and should be pulled up to Host\\ Vcc~with~a~10k\Omega~resistor.$		
3	TX Disable	Transmitter Disable In (LVTTL)	Logic "1" Input (or no connection) = Laser off Logic "0" Input = Laser on This pin is internally pulled up to VccT with a 10 $k\Omega$ resistor.		
4	SDA				
5	SCL	Module Definition Identifiers	Serial ID with SFF 8472 Diagnostics Module Definition pins should be pulled up to Host Vcc with 10 k $\Omega$ resistors.		
6	MOD-ABS				
7	RS0	Receiver Rate Select (LVTTL) Transmitter Rate Select (LVTTL)	NA		
9	RS1		NA		
8	LOS	Loss of Signal Out (OC)	This pin is open collector compatible, and should be pulled up to Host Vcc with a $10k\Omega$ resistor.		
10,11,14	VeeR	Receiver Signal Ground	These pins should be connected to signal ground on the host board.		
12	RD-	Receiver Negative DATA Out (CML)	Light on = Logic "0" Output Receiver DATA output is internally AC coupled and series terminated with a $50\Omega$ resistor.		
13	RD+	Receiver Positive DATA Out(CML)	Light on = Logic "1" Output Receiver DATA output is internally AC coupled and series terminated with a $50\Omega$ resistor.		
15	VccR	Receiver Power Supply	This pin should be connected to a filtered +3.3V power supply on the host board. See Figure 3.Recommended power supply filter		
16	VccT	Transmitter Power Supply	This pin should be connected to a filtered +3.3V power supply on the host board. See Figure 3.Recommended power supply filter		
18	TD+	Transmitter Positive DATA In(CML)	Logic "1" Input = Light on Transmitter DATA inputs are internally AC coupled and terminated with a differential $100\Omega$ resistor.		
19	TD-	Transmitter Negative DATA In(CML)	Logic "0" Input = Light on Transmitter DATA inputs are internally AC coupled and terminated with a differential $100\Omega$ resistor.		



# VII. Optical Module Block Diagram

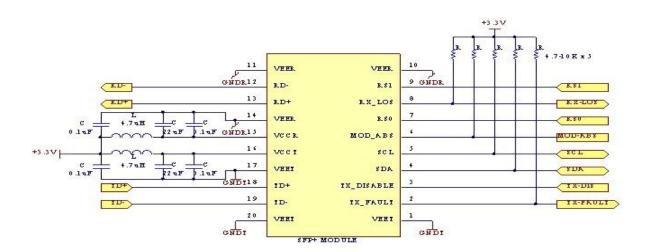


# **VIII. Regulatory Compliance**

Feature	Test Method	Performance		
Electrostatic Discharge (ESD)  to the Electrical Pins	MIL-STD-883C Method 3015.7	Class 1 (> 1500 Volts)		
Electrostatic Discharge (ESD) Immunity	Variation of IEC 61000-4-2	LV 4(Air discharge :15KV;Contact discharge:8 KV)		
Electromagnetic Interference (EMI)	CISPR22 ITE Class B EN55022 Class B FCC Class B	Compliant with standards		
Immunity	IEC61000-4-3 Class 2 EN55024	Typically show no measurable effect from a 3V/m fieldswept from 80 to 1000MHz applied to the transceiver without a chassis enclosure		



# **IX. Typical Application Circuit**



# X. Diagram Mechanial Drawing

